

Contents

1. Sensor Board Details	2
1.1 Test Conditions	2
1.2 Tx Coil and Frequency Parameters	2
1.3 Calibration Register Settings	2
1.4 Sensor Board	3
1.5 Sensor Target	4
2. Measurement Setup	5
2.1 General	5
2.2 Design-Specific Test Setup	5
3. Measurement Results	6
3.1 Angle Error at Different Air Gaps	6
3.2 Angle Error at Different Displacements	8
3.3 Angle Error at Different Tilt	9
4. Revision History	10

Figures

Figure 1. Sensor Board	3
Figure 2. Sensor Target	4
Figure 3. Setup	5
Figure 4. Error over Air Gap	6
Figure 5. Sine over Air Gap	7
Figure 6. Cosine over Air Gap	7
Figure 7. Error over Displacement	8
Figure 8. Error over Tilt	9

Tables

Table 1. Sensor Characteristics	2
Table 2. Sensor Characteristics	2
Table 3. Registers Dump	2

1. Sensor Board Details

Table 1. Sensor Characteristics

Ref. Design ID	Design Type	Single/Redundant	Number of Pole Pairs	PCB Size [mm]	Coil Size D _{out} / D _{in} [mm]	Target Size D _{out} / D _{in} [mm]	Air Gap (Nominal) [mm]	Accuracy (Nominal) [deg mech.] / [deg el.]
R_42_V31	Rotary	Single	4	64 x 40	32 / 18	35 / 13	2.0	±0.051 / ±0.204

1.1 Test Conditions

- Measurements are done in a lab environment at room temperature
- Sensor Board is powered using the IPS communication board
- The supply voltage level is 5V (VDD = 5V)
- The nominal accuracy is measured @ nominal air gap and 1000 RPM
- Inductance and the DC resistance of the transmitter coil is measured using a Smart Tweezer ST5S LCR Meter.

1.2 Tx Coil and Frequency Parameters

Set C_{TX} transmit frequency between 2.2 and 5.6 MHz. To ensure a high quality factor, a C0G capacitor was used. F_{TX} is calculated from the measured inductance and the nominal capacitor values. F_{TX} was measured by the IC itself.

Table 2. Sensor Characteristics

L _{TX}	R _L	C _{TX}	F _{TX} calc.	F _{TX} meas.
1.6 μH	1.31 Ω	1100 pF	3.794 MHz	3.75 MHz

1.3 Calibration Register Settings

The bias current (address 0x07) was set using the following equation:

$$I_{Bias} = 0.06 \cdot VDD \cdot R_L \cdot \frac{C_{TX}}{L_{TX}}$$

The receiver gain (address 0x02) is set to get an output level 1.4V to 2.5V for 5V operation. The sensor signals is calibrated at the nominal air gap without any displacement before the measurement. Amplitude mismatch is calibrated using the receiver fine gain registers (address 0x03 and 0x05), and signal offsets are compensated using the receiver offset registers (address 0x04 and 0x06) of IPS2200.

Table 3. Registers Dump

0x00	0x01	0x02	0x03	0x04	0x05	0x06	0x07	0x08
0x0323	0x0101	0x008C	0x0000	0x0046	0x0000	0x0045	0x00A2	0x015E
0x09	0x0A	0x0B	0x0C	0x0D	0x0E	0x12	0x13	
0x0000	0x0000	0x0000	0x0000	0x0000	0x0000	0x000A	0x0001	

1.4 Sensor Board

Figure 1. displays the sensor board layout, consisting of one transmit coil, two receive coils, IPS2200 and additional passive components.

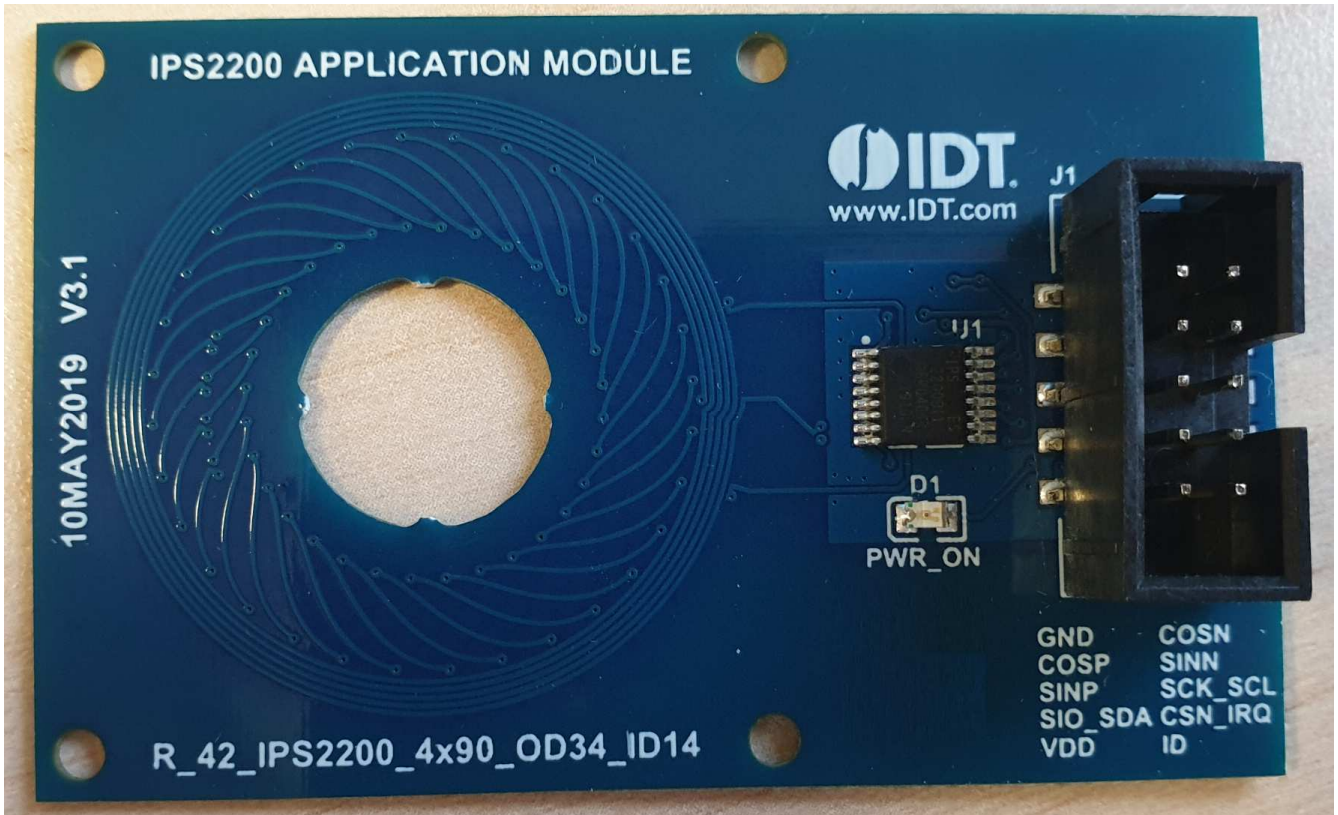


Figure 1. Sensor Board

1.5 Sensor Target

Figure 2. displays the target used during the measurements.



Figure 2. Sensor Target

2. Measurement Setup

2.1 General

All measurements are performed on a 4-axis positioning test bench. During the measurement, the target is rotating continuously. The rotor position is calculated from the sensor output signals and compared to the rotor position measured by high precision reference encoder.

$$f_{mechanical} = real\ sensor\ position - ideal\ position\ value$$

2.2 Design-Specific Test Setup

Figure 3. displays the test setup, the sensor board and target are mounted on the 4 axis positioning test bench.

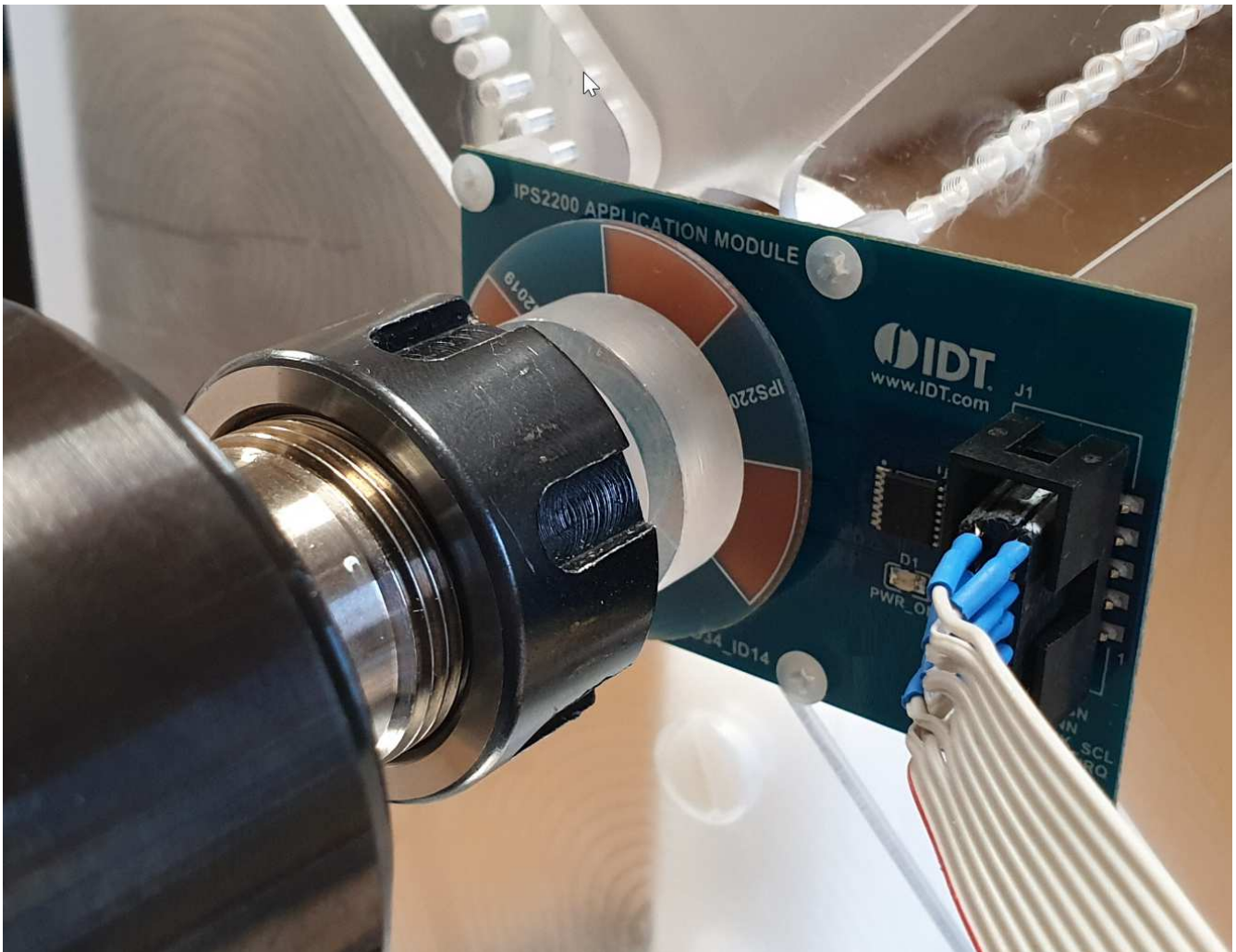


Figure 3. Setup

3. Measurement Results

3.1 Angle Error at Different Air Gaps

Figure 4. displays a series of data over a rotation of 360 degrees with a variation of air gap with no mechanical x,y displacement. Measurements are taken with the original memory settings, as shown in Table 3. No further offset cancelation and gain mismatch compensation is performed.

Example: X0.000_Y0.000_AG2.000

- Air Gap = 2.00mm
- X radial displacement = 0.00mm
- Y radial displacement = 0.00mm

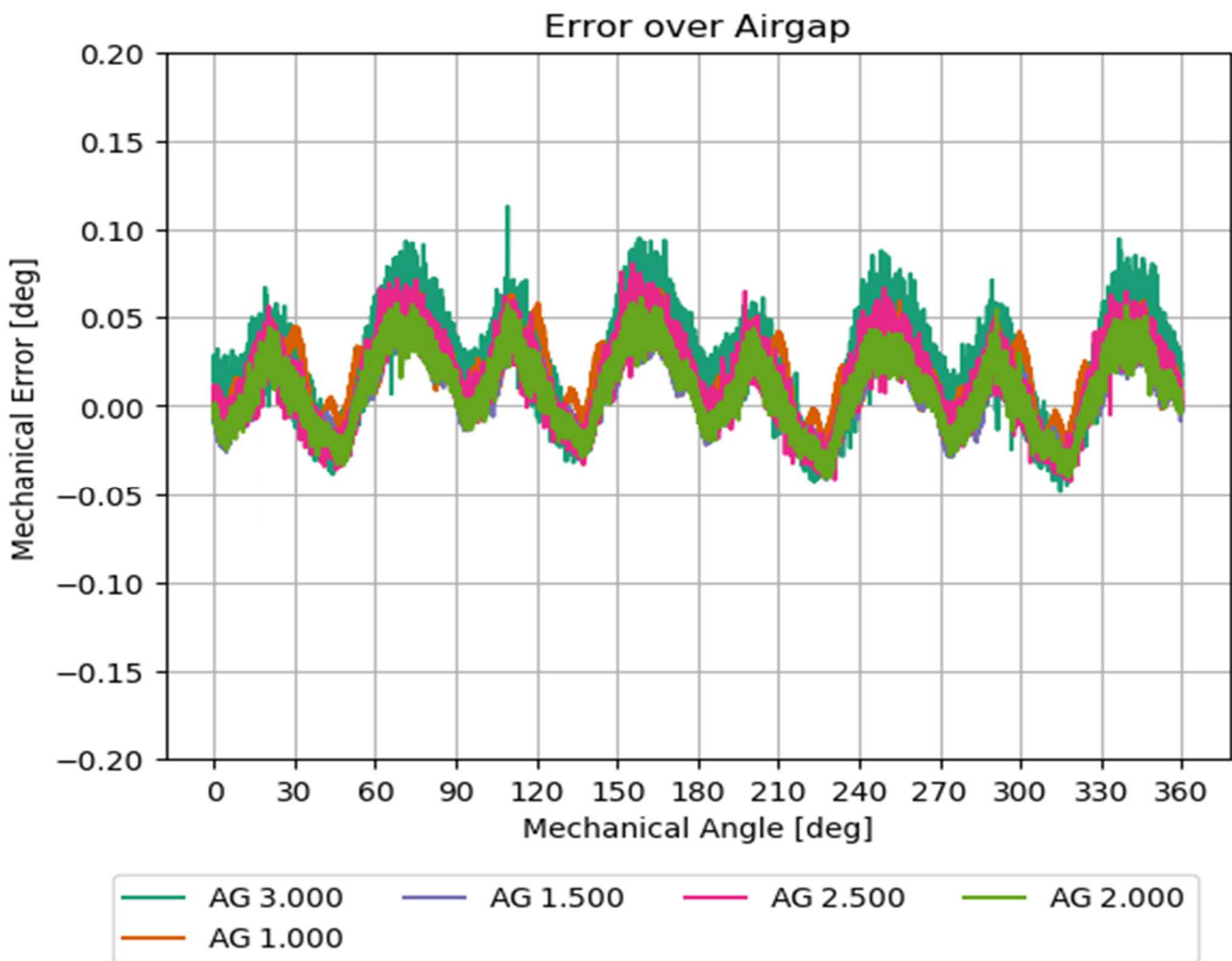


Figure 4. Error over Air Gap

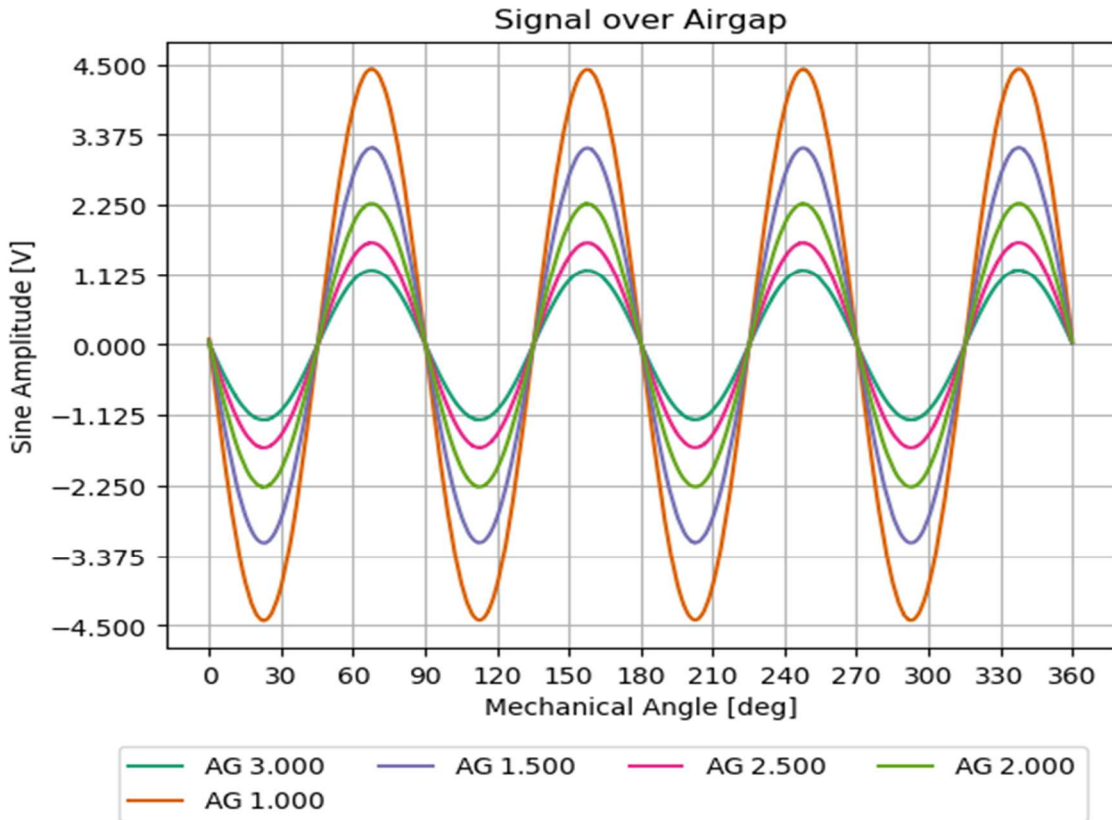


Figure 5. Sine over Air Gap

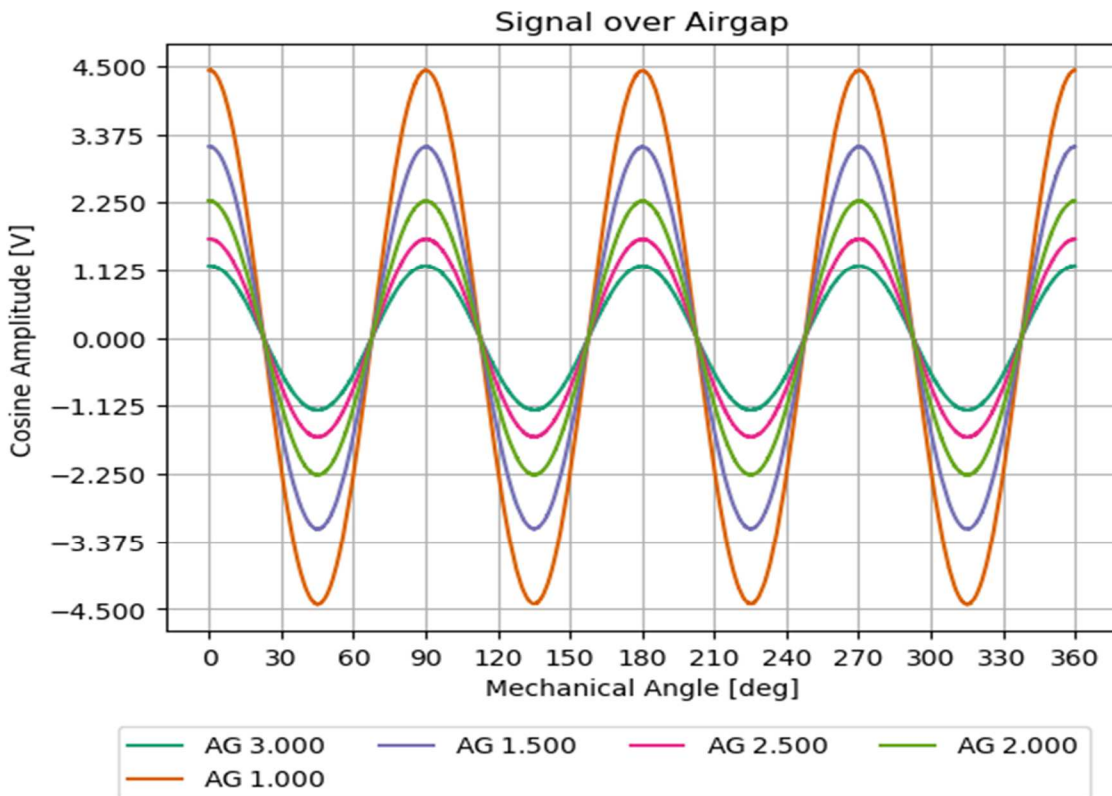


Figure 6. Cosine over Air Gap

3.2 Angle Error at Different Displacements

Figure 7. displays a series of data over a rotation of 360 degrees with no variation of air gap but with mechanical x,y displacement. Measurements are taken with the original memory settings, as shown in Table 3. No further offset cancelation and gain mismatch compensation is performed.

Example: X0.000_Y-0.250_AG2.000

- Air Gap = 2.00mm
- X radial displacement = 0.00mm
- Y radial displacement = -0.25mm

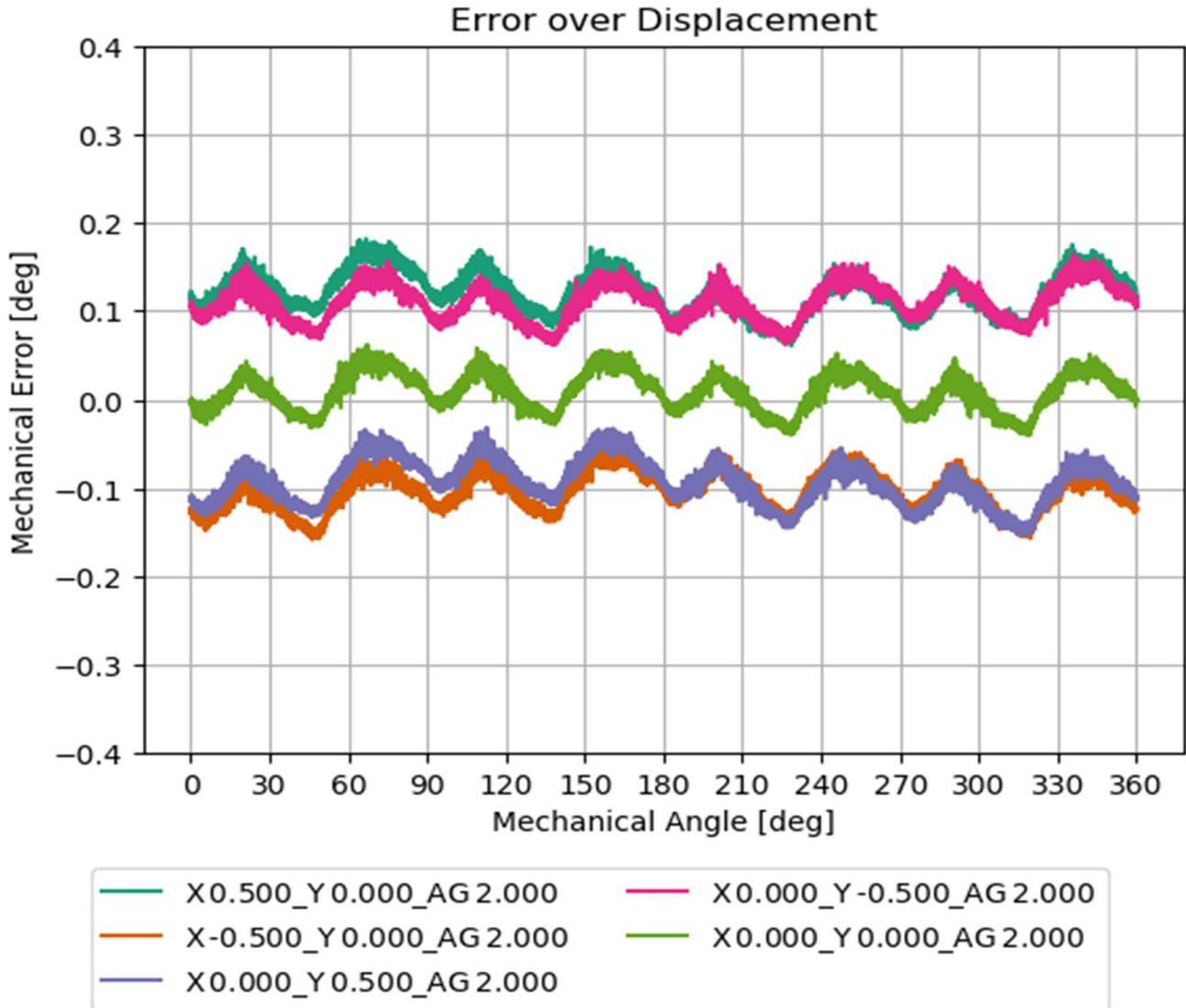


Figure 7. Error over Displacement

3.3 Angle Error at Different Tilt

Figure 8. displays a series of data over a rotation of 360 degrees with neither variation of air gap nor mechanical x,y displacement but with tilt variation. The tilt (ϕ) is given in degrees. Measurements are taken with the original memory settings, as shown in Table 3. No further offset cancelation and gain mismatch compensation is performed.

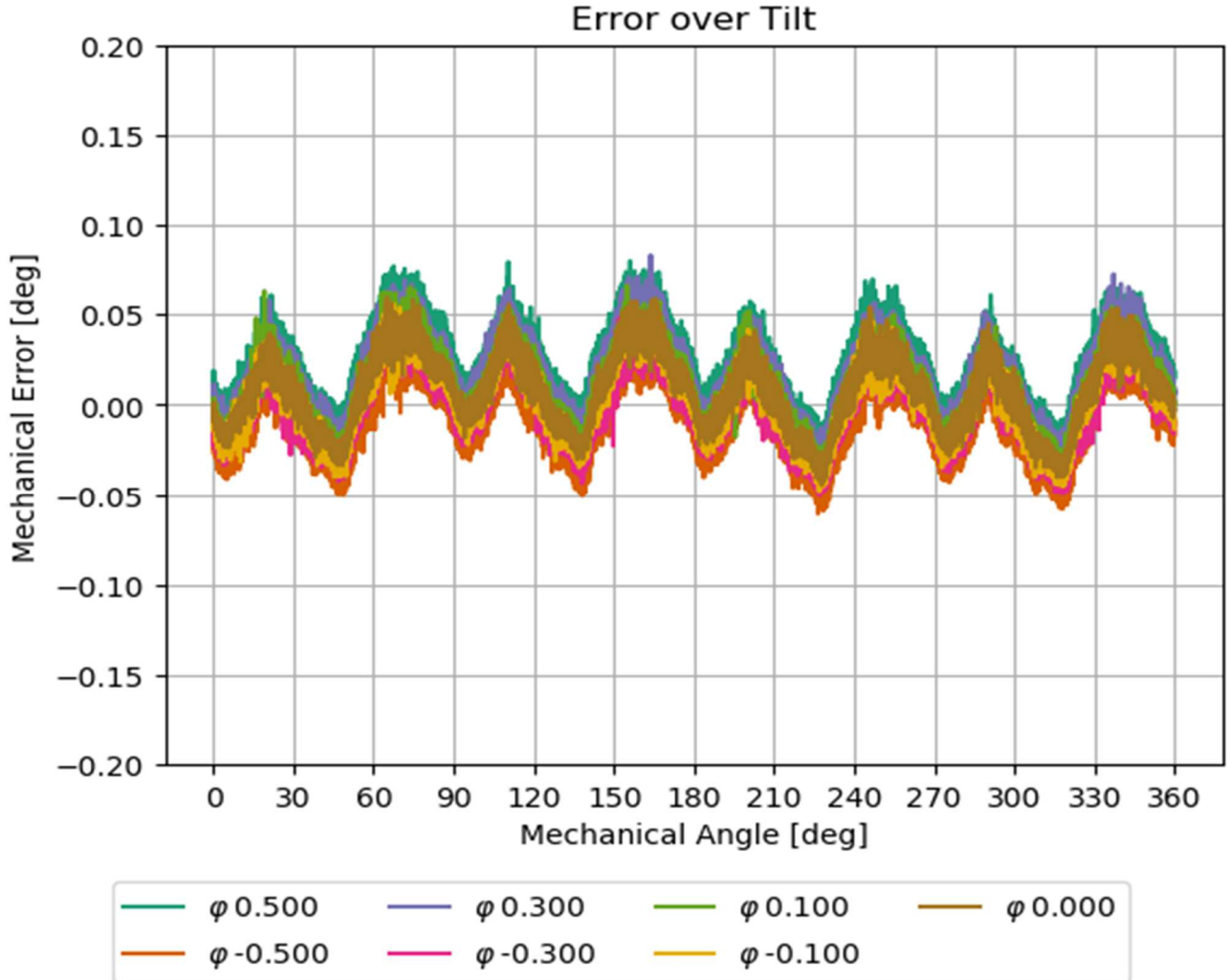


Figure 8. Error over Tilt

4. Revision History

Revision	Date	Description
	Mar. 31, 20	Initial release.

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